

Advanced Power MOSFET

SSH7N90A

FEATURES

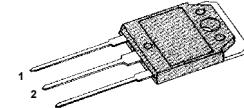
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 25 μ A (Max.) @ $V_{DS} = 900V$
- Low $R_{DS(ON)}$: 1.247 Ω (Typ.)

$BV_{DSS} = 900 V$

$R_{DS(on)} = 1.8 \Omega$

$I_D = 7 A$

TO-3P



1.Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	900	V
I_D	Continuous Drain Current ($T_c=25^\circ C$)	7	A
	Continuous Drain Current ($T_c=100^\circ C$)	4.4	
I_{DM}	Drain Current-Pulsed	28	A
V_{GS}	Gate-to-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy	778	mJ
I_{AR}	Avalanche Current	7	A
E_{AR}	Repetitive Avalanche Energy	24	mJ
dv/dt	Peak Diode Recovery dv/dt	1.5	V/ns
P_D	Total Power Dissipation ($T_c=25^\circ C$)	240	W
	Linear Derating Factor	1.92	W/ $^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +150	$^\circ C$
	Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	0.52	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink	0.24	--	
$R_{\theta JA}$	Junction-to-Ambient	--	40	

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Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	900	--	--	V	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	1.06	--	V/ $^\circ\text{C}$	$I_D=250\mu\text{A}$ See Fig 7
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0	--	3.5	V	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$
I_{GSS}	Gate-Source Leakage , Forward	--	--	100	nA	$V_{GS}=30\text{V}$
	Gate-Source Leakage , Reverse	--	--	-100		$V_{GS}=-30\text{V}$
I_{DSS}	Drain-to-Source Leakage Current	--	--	25	μA	$V_{DS}=900\text{V}$
		--	--	250		$V_{DS}=720\text{V}, T_C=125^\circ\text{C}$
$R_{DS(\text{on})}$	Static Drain-Source On-State Resistance	--	--	1.8	Ω	$V_{GS}=10\text{V}, I_D=3.5\text{A}$ ④ *
g_{fs}	Forward Transconductance	--	5.8	--	S	$V_{DS}=50\text{V}, I_D=3.5\text{A}$ ④
C_{iss}	Input Capacitance	--	2070	2690	pF	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	--	185	215		
C_{rss}	Reverse Transfer Capacitance	--	78	90		
$t_{d(on)}$	Turn-On Delay Time	--	25	60		
t_r	Rise Time	--	38	85	ns	$V_{DD}=450\text{V}, I_D=8\text{A}, R_G=10\Omega$ See Fig 13 ④ ⑤
$t_{d(off)}$	Turn-Off Delay Time	--	122	255		
t_f	Fall Time	--	41	90		
Q_g	Total Gate Charge	--	94	123	nC	$V_{DS}=720\text{V}, V_{GS}=10\text{V}, I_D=8\text{A}$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	--	14.9	--		
Q_{gd}	Gate-Drain(漏极?) Charge	--	43.5	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	7	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	28		
V_{SD}	Diode Forward Voltage ④	--	--	1.4	V	$T_J=25^\circ\text{C}, I_S=7\text{A}, V_{GS}=0\text{V}$
t_{rr}	Reverse Recovery Time	--	620	--	ns	$T_J=25^\circ\text{C}, I_F=8\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$ ④
Q_{rr}	Reverse Recovery Charge	--	9.3	--	μC	

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=30\text{mH}, I_{AS}=7\text{A}, V_{DD}=50\text{V}, R_G=27\Omega$, Starting $T_J=25^\circ\text{C}$
- ③ $I_{SD}\leq 8\text{A}, di/dt\leq 170\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = $250\mu\text{s}$, Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

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Fig 1. Output Characteristics

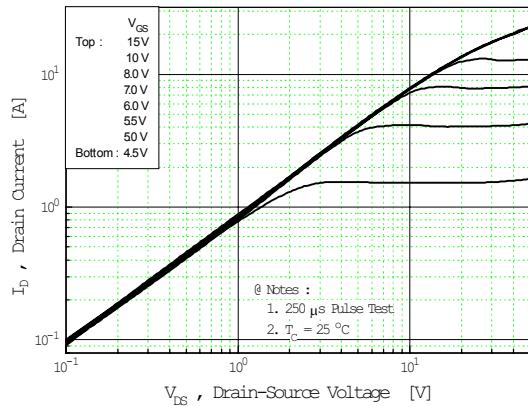


Fig 2. Transfer Characteristics

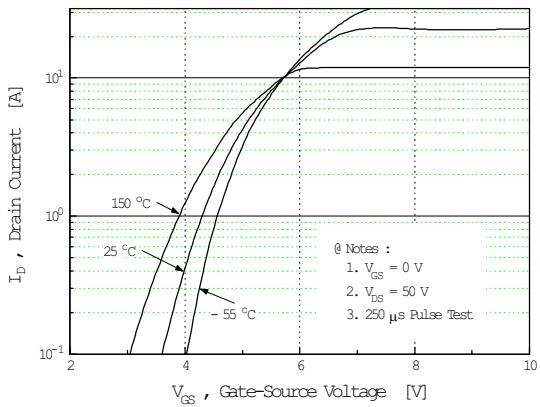


Fig 3. On-Resistance vs. Drain Current

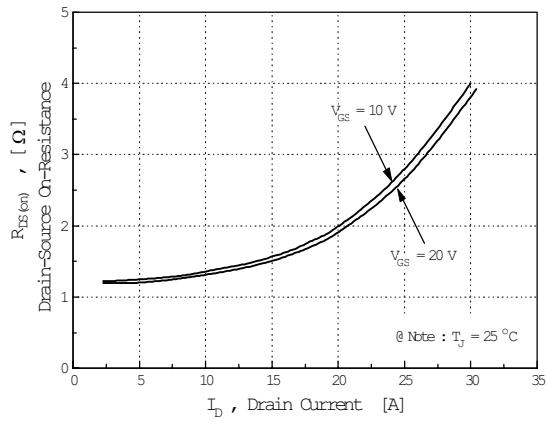


Fig 4. Source-Drain Diode Forward Voltage

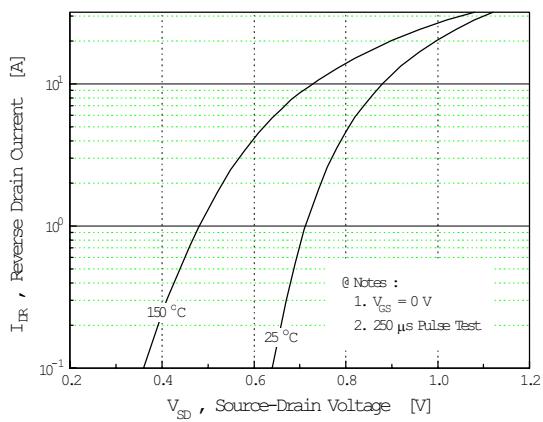


Fig 5. Capacitance vs. Drain-Source Voltage

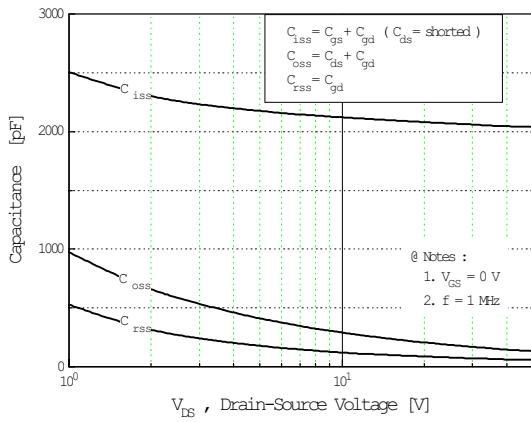
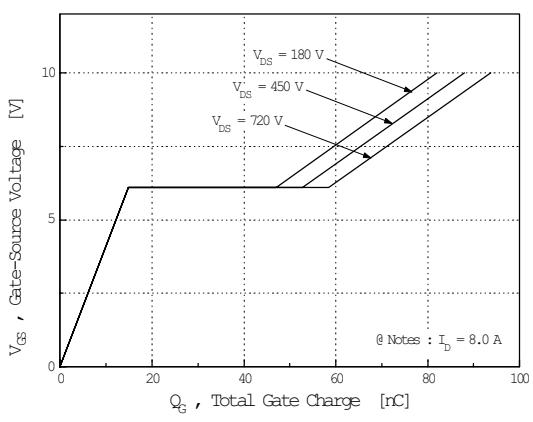


Fig 6. Gate Charge vs. Gate-Source Voltage



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Fig 7. Breakdown Voltage vs. Temperature

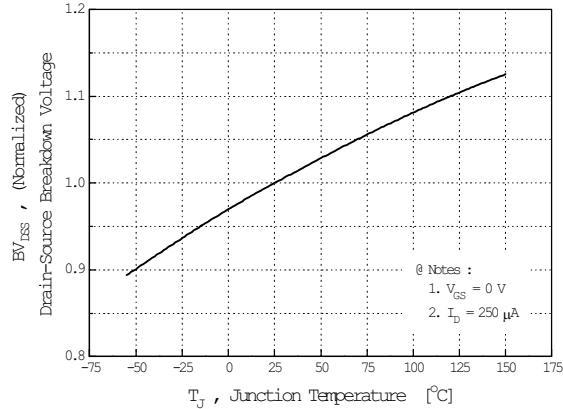


Fig 8. On-Resistance vs. Temperature

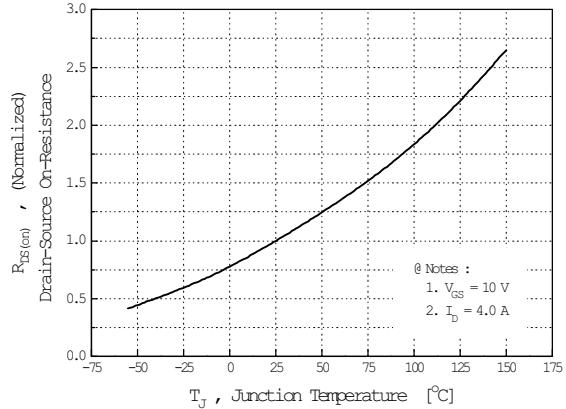


Fig 9. Max. Safe Operating Area

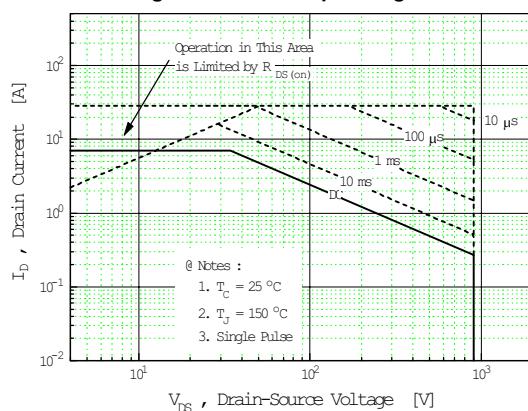


Fig 10. Max. Drain Current vs. Case Temperature

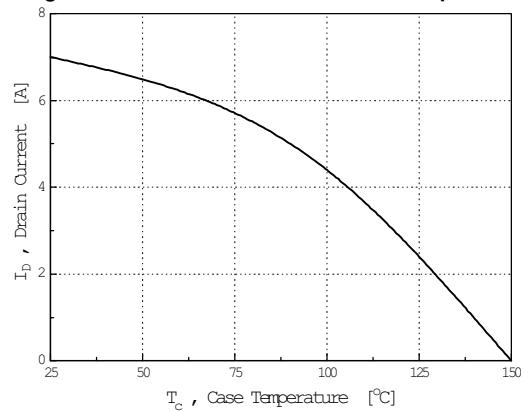


Fig 11. Thermal Response

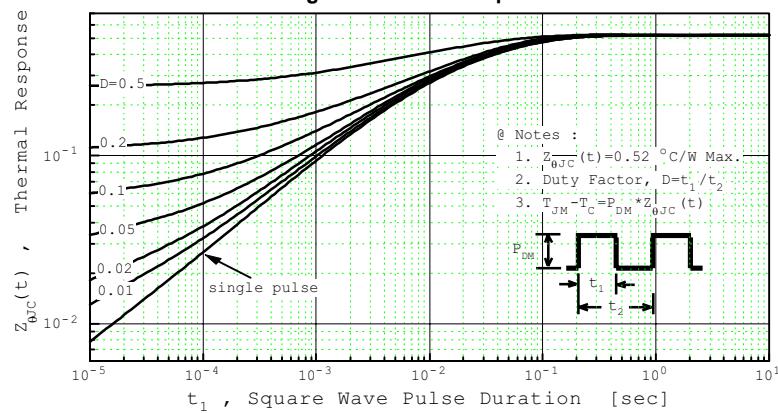


Fig 12. Gate Charge Test Circuit & Waveform

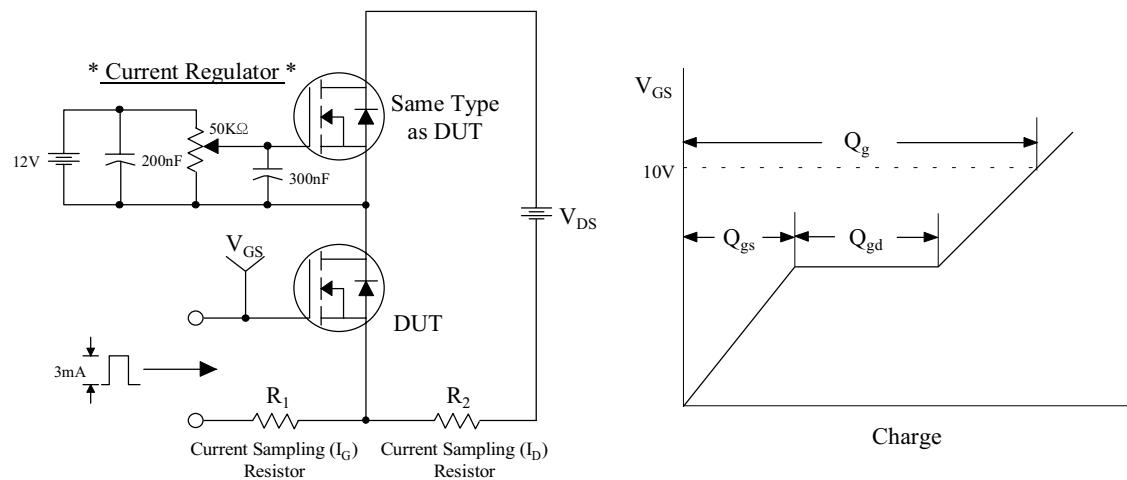


Fig 13. Resistive Switching Test Circuit & Waveforms

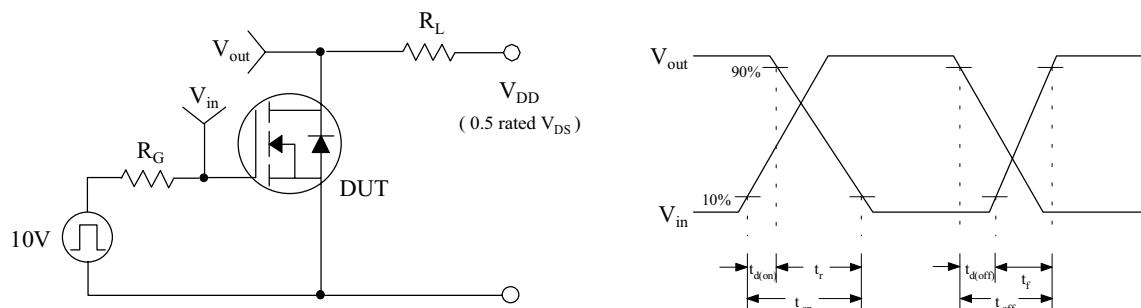


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

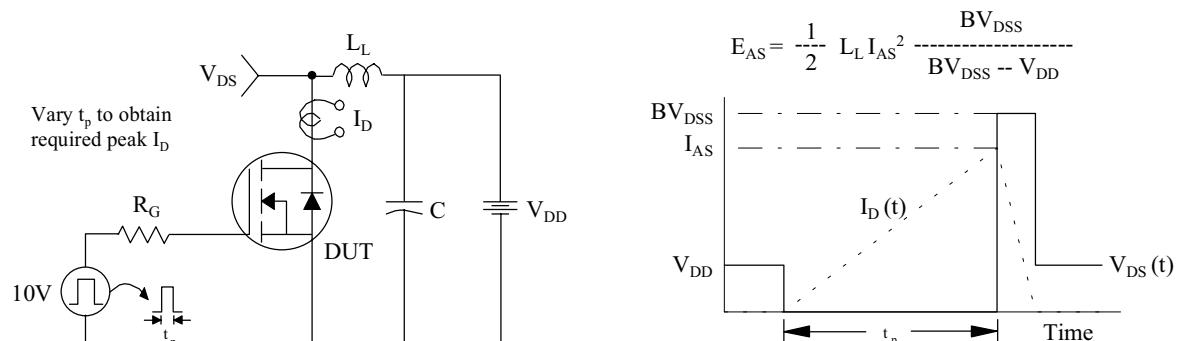


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

